

06-30-2005

Atty. Dkt. No. 5298-18801

To the Honorable Commissioner of Patents and Trademarks. Please



103031866

1. Name of conveying party(ies):

Christopher A. Seams, Yonghong Yang,  
Clifford P. Sandstrom, and Parkash R. Krishnan

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of Conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: June 16, 2005

2. Name and address of receiving party(ies):

Name: Cypress Semiconductor Corp.

Internal Address: \_\_\_\_\_

Street Address: 3901 N. First Street

City: San Jose State: CA ZIP 95134

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of this application is: June 16, 2005

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Daffer McDaniel, LLP

Internal Address: \_\_\_\_\_

Street Address: P.O. Box 684908

City Austin State TX ZIP 78768-4908

6. Total number of applications and patents involved: one (1)

7. Total fee (37 CFR 3.41): .....\$ 40.00

☐ Enclosed

☒ Authorized to be charged to deposit account

8. Deposit account number: 50-3268/5298-18801

(Attach a duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and Signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Kevin L. Daffer

Name of Person Signing  
Reg. No. 34,146

[Signature]  
Signature

June 22, 2005

Date

Total number of pages including cover sheet: 9

OMB No. 0651-011 (exp.4/94)

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06/29/2005 GTON11 00000108 503268 11158513

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PATENT  
5298-18801  
PM02058

### ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned, does hereby:

SELL, ASSIGN AND TRANSFER to CYPRESS SEMICONDUCTOR CORPORATION (the "Assignee"), having a place of business at 3901 North First Street, San Jose, CA, 95134 the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith, and is entitled "METHOD FOR ARRANGING A SEMICONDUCTOR WAFER WITHIN A PHOTOLITHOGRAPHY TOOL." such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee; and

COVENANT AND AGREE that the above is and will be binding on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

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FURTHER COVENANT that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(Signature)

  
Christopher A. SeamsDate: 6-16-05

(Signature)

Yonghong Yang

Date: \_\_\_\_\_

(Signature)

Clifford P. Sandstrom

Date: \_\_\_\_\_

(Signature)

Prakash R. Krishanan

Date: \_\_\_\_\_

Please direct all communication as follows:

**Customer No. 35617**  
Daffer McDaniel, LLP  
P.O. Box 684908  
Austin, Texas 78768-4908  
Ph: (512) 476-1400

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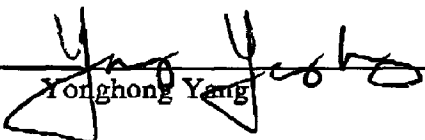
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(Signature) \_\_\_\_\_  
Christopher A. Seams

Date: \_\_\_\_\_

(Signature)  \_\_\_\_\_  
Yonghong Yang

Date: 06/14/05

(Signature) \_\_\_\_\_  
Clifford P. Sandstrom

Date: \_\_\_\_\_

(Signature) \_\_\_\_\_  
Prakash R. Krishanan

Date: \_\_\_\_\_

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